

# SANYO Semiconductors

# DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

# **ECH8653** — General-Purpose Switching Device Applications

#### **Features**

- · Low ON-resistance
- · Best suited for LiB charging and discharging switch
- · Halogen free compliance

- 4V drive
- · Common-drain type
- · Protection diode in

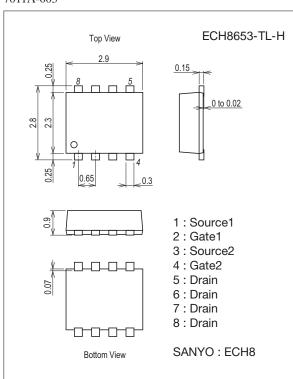
#### **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		20	V
Gate-to-Source Voltage	VGSS		±10	V
Drain Current (DC)	ID		7.5	Α
Drain Current (Pulse)	I <sub>DP</sub>	PW≤10μs, duty cycle≤1%	40	Α
Allowable Power Dissipation	PD	When mounted on ceramic substrate (900mm <sup>2</sup> x0.8mm) 1unit	1.4	W
Total Power Dissipation	PT	When mounted on ceramic substrate (900mm <sup>2</sup> ×0.8mm)	1.5	W
Channel Temperature	Tch		150	C
Storage Temperature	Tstg		-55 to +150	C

#### **Package Dimensions**

unit : mm (typ) 7011A-003

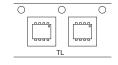


#### **Product & Package Information**

Package : ECH8JEITA, JEDEC : -

• Minimum Packing Quantity : 3,000 pcs./reel

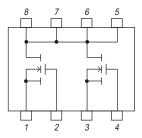
#### Packing Type: TL



#### Marking



#### **Electrical Connection**

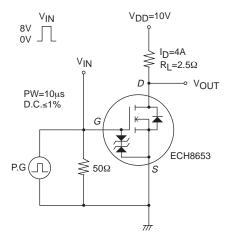


#### **ECH8653**

#### **Electrical Characteristics** at Ta=25°C

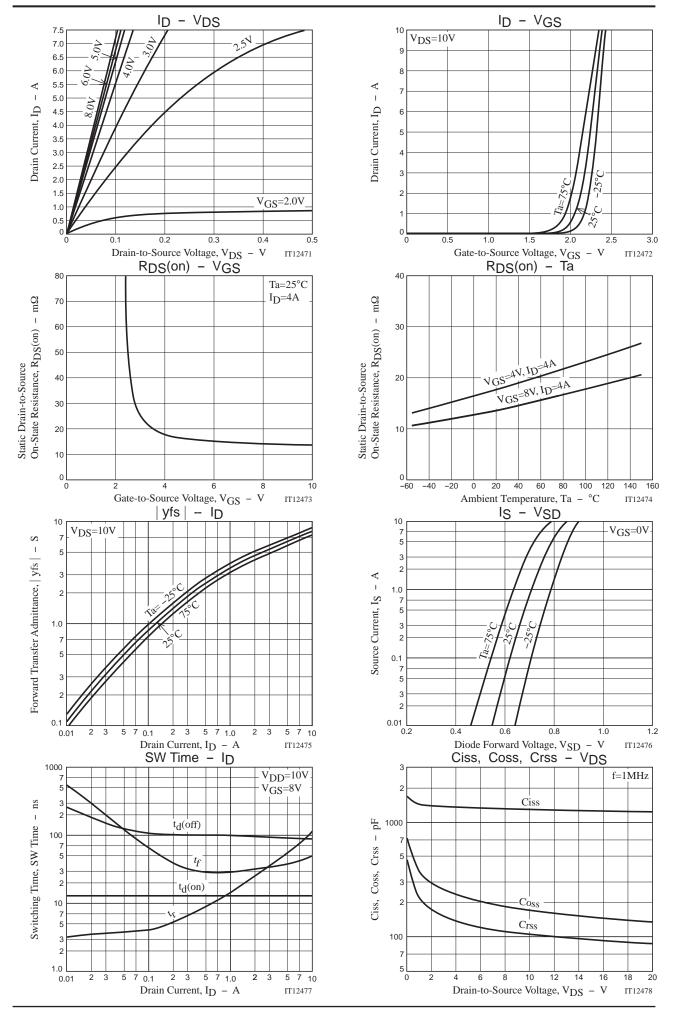
Parameter	Symbol	Conditions	Ratings			Unit	
Farameter	Syllibol	Conditions	min	typ	max	Onit	
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	20			V	
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	μΑ	
Gate-to-Source Leakage Current	IGSS	VGS=±8V, VDS=0V			±10	μΑ	
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	1.0		2.4	V	
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =4A	3.4	5.8		S	
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)1	I <sub>D</sub> =4A, V <sub>G</sub> S=8V	9	14	20	$m\Omega$	
	R <sub>DS</sub> (on)2	ID=4A, VGS=4V	11	18	25	$m\Omega$	
Input Capacitance	Ciss			1280		pF	
Output Capacitance	Coss	VDS=10V, f=1MHz		170		pF	
Reverse Transfer Capacitance	Crss			105		pF	
Turn-ON Delay Time	t <sub>d</sub> (on)			13		ns	
Rise Time	t <sub>r</sub>	San an acified Test Circuit		48		ns	
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		94		ns	
Fall Time	tf			36		ns	
Total Gate Charge	Qg			18.5		nC	
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =10V, V <sub>GS</sub> =8V, I <sub>D</sub> =7.5A		2.7		nC	
Gate-to-Drain "Miller" Charge	Qgd			3.1		nC	
Diode Forward Voltage	VSD	IS=7.5A, VGS=0V		0.82	1.2	V	

# **Switching Time Test Circuit**

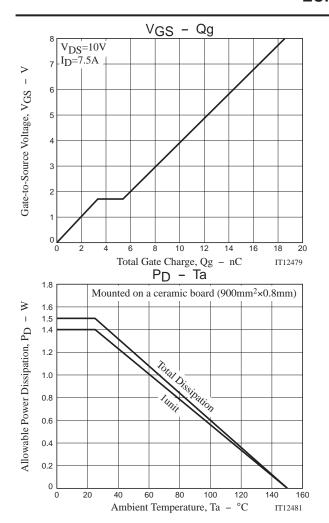


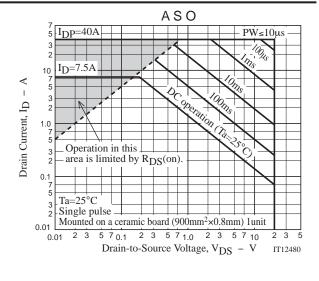
### **Ordering Information**

Device	Package	Shipping	memo	
ECH8653-TL-H	ECH8653-TL-H ECH8		Pb Free and Halogen Free	



#### ECH8653



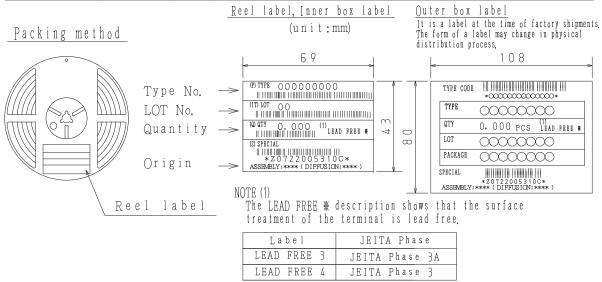


#### **Embossed Taping Specification**

#### ECH8653-TL-H

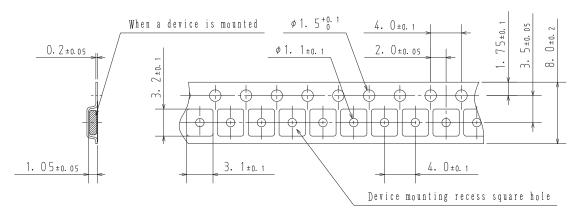
#### 1. Packing Format

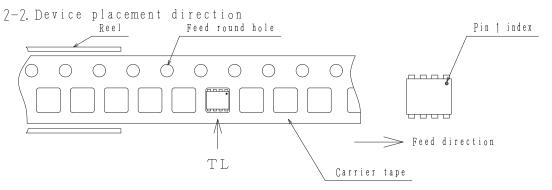
Package Name	Carrier Tape	Maximum Number of devices contained (pcs)			Packing	format
	Туре	Reel	Inner box	Outer box	Inner $BOX(C-1)$	Outer BOX (A-7)
ECH8	СРН6	3, 000	15, 000	90,000	5 reels contained	6 inner boxes contained
					Dimensions:mm (external)	Dimensions:mm (external)
					183×72×185	440×195×210



#### 2. Taping configuration

2-1. Carrier tape size (unit:mm)





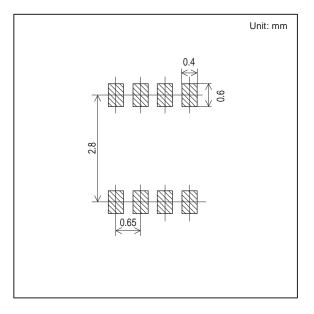
Those with pin 1 index on the feed hole side · · · · · TL

# **Outline Drawing**

ECH8653-TL-H

# 

# **Land Pattern Example**



Note on usage: Since the ECH8653 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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